

# **Product Compliance Declaration**

Please see <u>www.molex.com</u> for the most up-to-date information.

Contact Information						
Name	Molex Product Compliance	E-Mail	Product.Compliance@molex.com			
Part Inform	ation					
Part Number	0349128081	Part Weight	2.174G			
Part Name	MINI50 RAHDR SMT 8CKT GRY POL B T&R					

## **Product Composition**

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
MINI50 RAHDR SMT 8CKT GRY POL B T&R	Assembly		100	2.174
MINI50 HSNG RAHDR SMT 8CKT GRY POL B	Component		78.1969	1.7
PS-ST GF30	Material		78.1969	1.7
PS-ST	Substance		45.8918	0.997688
GF-Fibre	Substance		23.3613	0.507875
Pigment portion, not to declare	Substance	system	0.9579	0.020825
Benzene, ethenyl-, polymer with 1,3-butadiene, hydrogenated	Substance	66070-58-4	5.3223	0.115707
Further Additives, not to declare	Substance	system	2.6635	0.057905
MINI50 TERM SMT SOLDER NAIL LT MATTE SN	Component		6.1178	0.133
Cartridge Brass 70% Unplated	Material		5.7498	0.125
Copper	Substance	7440-50-8	4.0248	0.0875
Zinc (metal)	Substance	7440-66-6	1.7249	0.0375
Nickel Plating	Material		0.1288	0.0028

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Nickel	Substance	7440-02-0	0.1288	0.0028
Further Additives, not to declare	Substance	system	1E-05	3E-07
Tin Plating	Material		0.2392	0.0052
Tin	Substance	7440-31-5	0.2392	0.0052
MINI50 TERM SMT SOLDER NAIL RT MATTE SN	Component		5.7498	0.125
Cartridge Brass 70% Unplated	Material		5.3818	0.117
Copper	Substance	7440-50-8	3.7672	0.0819
Zinc (metal)	Substance	7440-66-6	1.6145	0.0351
Nickel Plating	Material		0.1288	0.0028
Nickel	Substance	7440-02-0	0.1288	0.0028
Further Additives, not to declare	Substance	system	1E-05	3E-07
Tin Plating	Material		0.2392	0.0052
Tin	Substance	7440-31-5	0.2392	0.0052
MINI50 TERM BLD 0.50X15.57 MATTE SN	Component		9.9356	0.216
Cartridge Brass 70% Unplated	Material		8.8316	0.192
Copper	Substance	7440-50-8	6.1822	0.1344
Zinc (metal)	Substance	7440-66-6	2.6495	0.0576
Nickel Plating	Material		0.4416	0.0096
Nickel	Substance	7440-02-0	0.4415	0.009599
Further Additives, not to declare	Substance	system	4E-05	1E-06
Tin Plating	Material		0.6624	0.0144
Tin	Substance	7440-31-5	0.6624	0.0144

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# **ROHS** Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

#### **Contained Substances Exceeding Threshold**

None

#### Exemptions

None

# **REACH-SVHC** Declaration Information

Regulatory Revision D(2021)4569-DC (8 July 2021)

## **Contained Substances Exceeding Threshold**

None

# **GADSL** Declaration Information

Regulatory Revision GADSL imported from IMDS

## **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
Lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	500	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes

\*Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Part Name	Exemption		
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits		
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits		

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Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

#### Exemptions

Part Name	Exemption
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/ cm2/week)

## **HFLH Declaration Information**

Regulatory Revision IEC 61249-2-21

#### **Contained Substances Exceeding Threshold**

None

## China ROHS Declaration Information

Part Number Part Name	0349128081 MINI50 RAHDR SMT 8CKT GRY POL B T&R						
Part Informatio	n		Haz	zardous S	Substance	s	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
MINI50 RAHI	DR SMT 8CKT GRY POL B T&R	0	0	0	0	0	0
MINI50 HSNG RAHDR SMT 8CKT GRY POL B		0	0	0	0	0	0
MINI50 TERM SMT SOLDER NAIL LT MATTE SN		0	0	0	0	0	0
MINI50 TERM	I SMT SOLDER NAIL RT MATTE SN	0	0	0	0	0	0
MINI50 TERM	/ BLD 0.50X15.57 MATTE SN	0	0	0	0	0	0

# **Additional Information**

Annex XVII to REACH (76/769/EEC)	Compliant
Regulation (EU) 2019/1021 (POP)	Compliant

# **Process Information**

Component Plating / Surface Finish	N/A
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Termination Base Alloy	N/A
Solder Alloy	N/A
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Dec 30, 2021

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